STGW50HF60S

60 A, 600 V, very low drop IGBT

Features

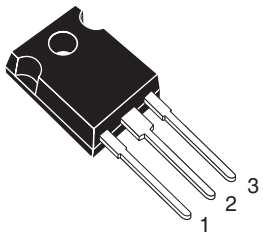
- Very low on-state voltage drop
- Low switching off
- High current capability

Applications

- PV inverter
- UPS

Description

STGW50HF60S is a very low drop IGBT based on new advanced planar technology, showing extremely low on-state voltage and limited turn-off losses. The overall performance makes this IGBT ideal in low frequency switches of mixed frequency topologies for PF ≤ 1.



TO-247

Figure 1. Internal schematic diagram

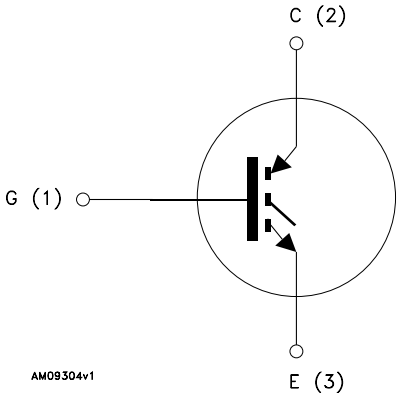


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW50HF60S	GW50HF60S	TO-247	Tube

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage (V_{GE} = 0)	600	V
I_C (1)	Continuous collector current at T_C = 25 °C	110	A
I_C (1)	Continuous collector current at T_C = 100 °C	60	A
I_{CL} (2)	Turn-off latching current	60	A
I_{CP} (3)	Pulsed collector current	130	A
V_{GE}	Gate-emitter voltage	±20	V
P_{TOT}	Total dissipation at T_C = 25 °C	284	W
T_j	Operating junction temperature	- 55 to 150	°C

1. Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{j(max)} - T_C}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_C(T_C))}$$

2. Vclamp = 80% of V_{CES}, T_j =150 °C, R_G=10 Ω, V_{GE}=15 V
3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case	0.44	°C/W
R_{thJA}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

T_J = 25 °C unless otherwise specified.

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage (V_{GE} = 0)	I_C = 1 mA	600			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	V_{GE}= 15 V, I_C= 30 A V_{GE}= 15 V, I_C= 30 A, T_J =125 °C		1.15 1.05	1.45	V V
$V_{GE(th)}$	Gate threshold voltage	V_{CE}= V_{GE}, I_C= 250 µA	3.5		5.7	V
I_{CES}	Collector cut-off current (V_{GE} = 0)	V_{CE} =600 V V_{CE} =600 V, T_J=125 °C			50 500	µA µA
I_{GES}	Gate-emitter leakage current (V_{CE} = 0)	V_{GE} =± 20 V			± 100	nA
g_{fs}	Forward transconductance	V_{CE} = 15 V, I_C= 30 A		25		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies} C_{oes} C_{res}	Input capacitance Output capacitance Reverse transfer capacitance	V_{CE} = 25 V, f = 1 MHz, V_{GE}=0	-	4300 400 100	-	pF pF pF
Q_g Q_{ge} Q_{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 480 V, I_C= 30 A,V_{GE}=15 V	-	200 27 90	-	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	V_{CC} = 400 V, I_C = 30 A		50		ns
t_r	Current rise time	R_G= 10 Ω, V_{GE}= 15 V,	-	20	-	ns
$(di/dt)_{on}$	Turn-on current slope	*(see Figure 14)*		1280		A/µs
$t_{d(on)}$	Turn-on delay time	V_{CC} = 400 V, I_C = 30 A		47		ns
t_r	Current rise time	R_G= 10 Ω, V_{GE}= 15 V,	-	22	-	ns
$(di/dt)_{on}$	Turn-on current slope	T_J = 125 °C *(see Figure 14)*		1100		A/µs
$t_r(V_{off})$	Off voltage rise time	V_{CC} = 400 V, I_C = 30 A		370		ns
$t_{d(off)}$	Turn-off delay time	R_G= 10 Ω, V_{GE}= 15 V,	-	220	-	ns
t_f	Current fall time	*(see Figure 14)*		465		ns
$t_r(V_{off})$	Off voltage rise time	V_{CC} = 400 V, I_C = 30 A		700		ns
$t_{d(off)}$	Turn-off delay time	R_G= 10 Ω, V_{GE}= 15 V,	-	250	-	ns
t_f	Current fall time	T_J = 125 °C *(see Figure 14)*		800		ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Eon (1)	Turn-on switching losses	V_{CC} = 400 V, I_C = 30 A		0.25		mJ
E_{off} (2)	Turn-off switching losses	R_G= 10 Ω, V_{GE}= 15 V,	-	4.2	-	mJ
E_{ts}	Total switching losses	*(see Figure 14)*		4.45		mJ
Eon (1)	Turn-on switching losses	V_{CC} = 400 V, I_C = 30 A		0.45		mJ
E_{off} (2)	Turn-off switching losses	R_G= 10 Ω, V_{GE}= 15 V,	-	7.8	-	mJ
E_{ts}	Total switching losses	T_J = 125 °C *(see Figure 14)*		8.25		mJ

1. Eon is the turn-on losses when a typical diode is used in the test circuit in *Figure 14*. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (25 °C and 125 °C).
2. Turn-off losses include also the tail of the collector current.

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

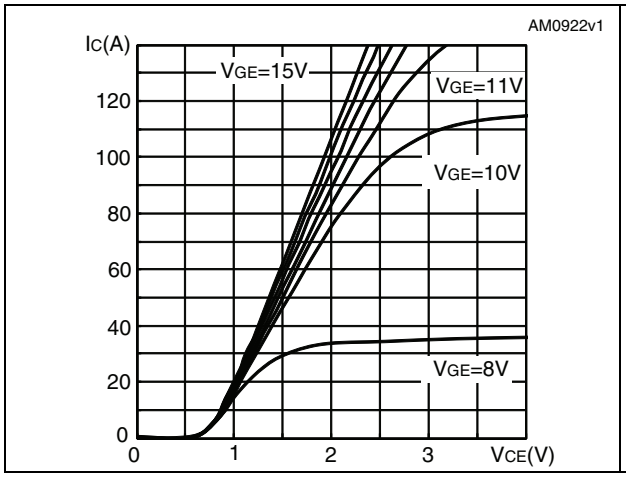


Figure 3. Transfer characteristics

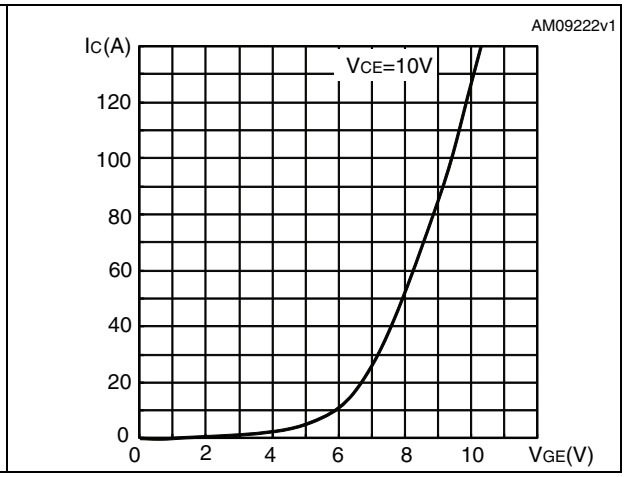


Figure 4. Collector-emitter on voltage vs. temperature

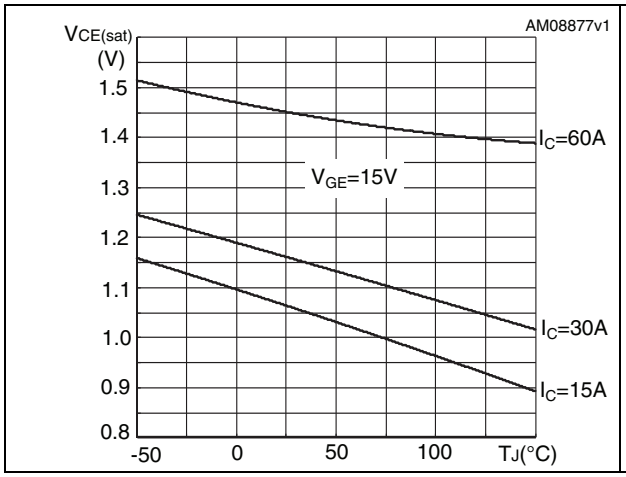


Figure 5. Collector-emitter on voltage vs. collector current

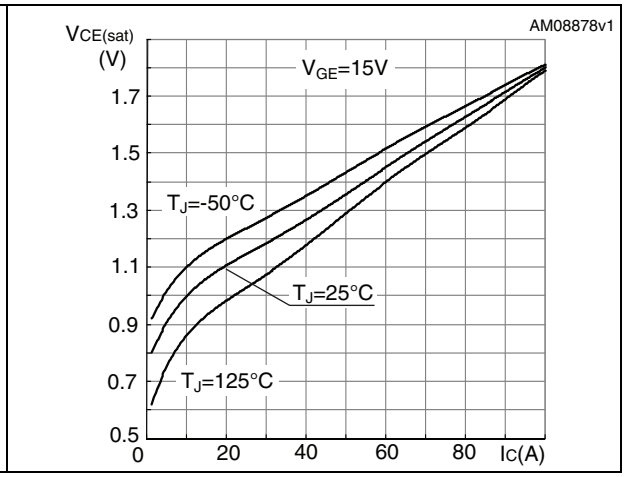


Figure 6. Breakdown voltage vs. temperature

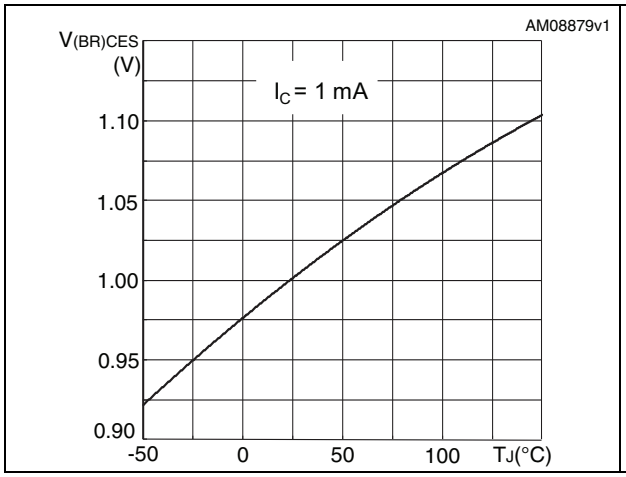


Figure 7. Gate threshold voltage vs. temperature

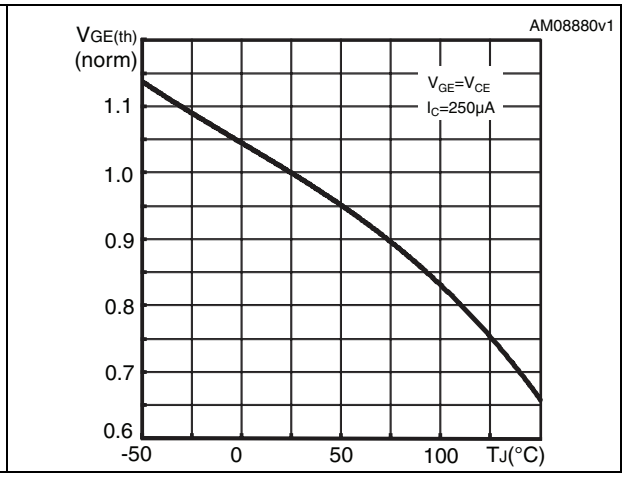


Figure 8. Gate charge vs. gate-emitter voltage

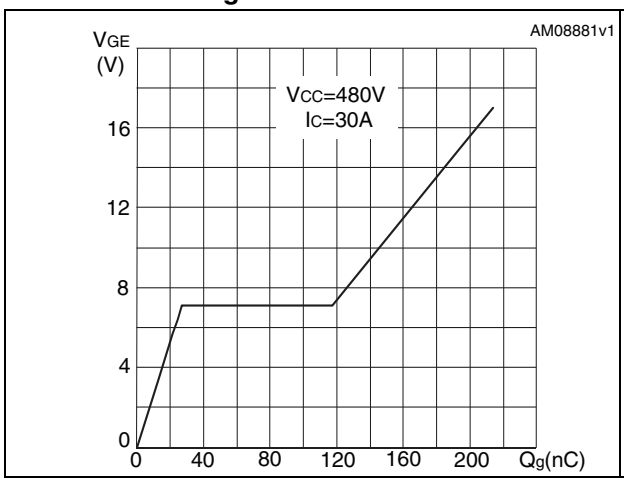


Figure 9. Capacitance variations

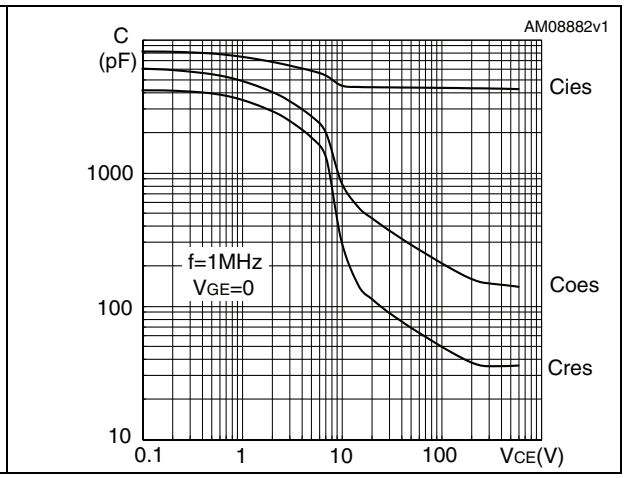


Figure 10. Switching losses vs. collector current

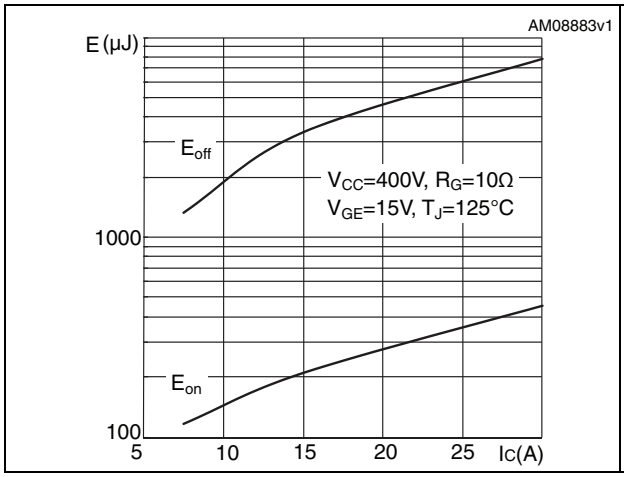


Figure 11. Switching losses vs. gate resistance

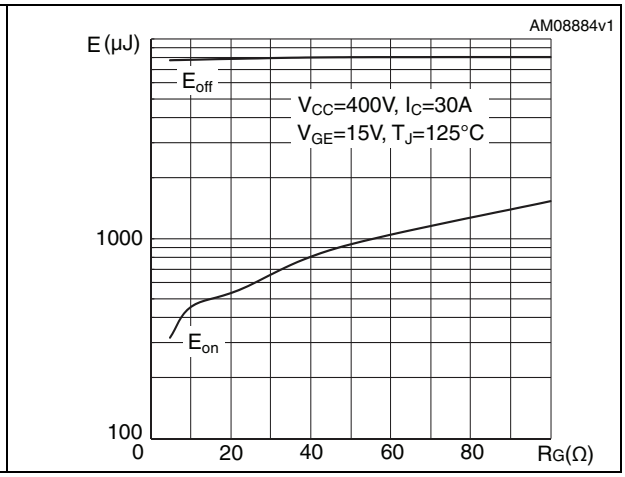


Figure 12. Switching losses vs. temperature

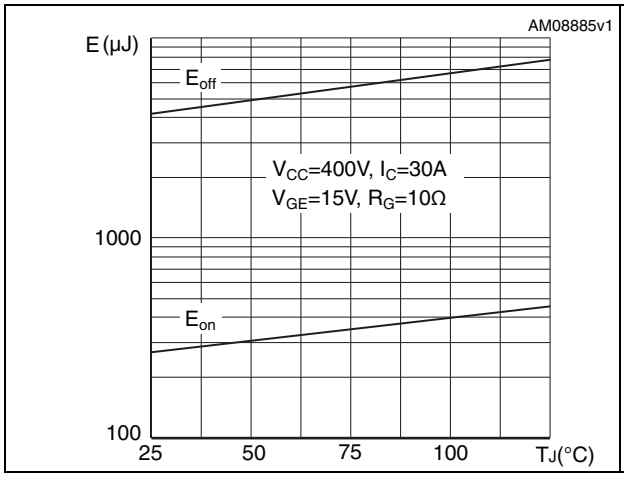
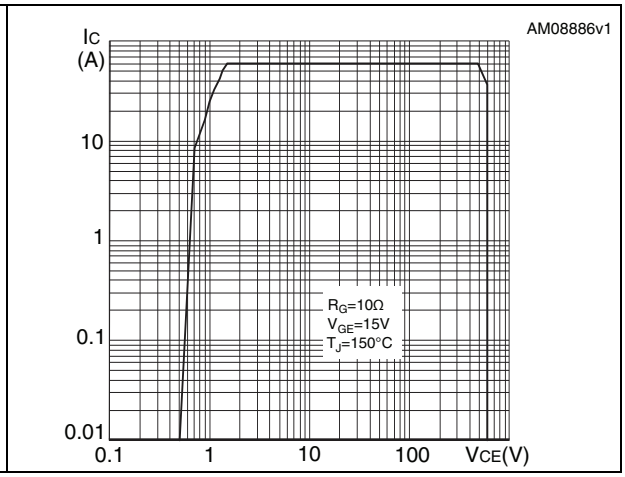


Figure 13. Turn-off SOA



3 Test circuits

Figure 14. Test circuit for inductive load switching

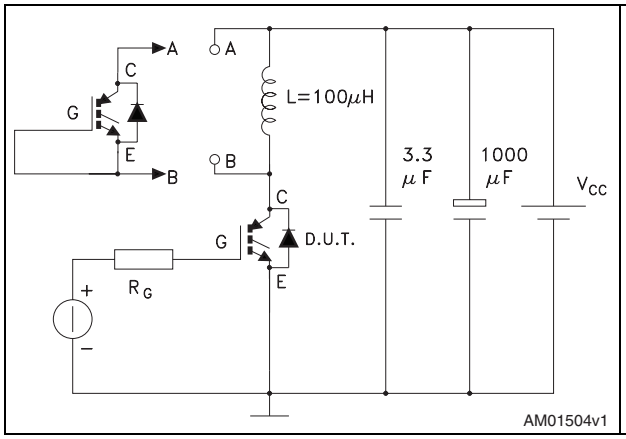


Figure 15. Gate charge test circuit

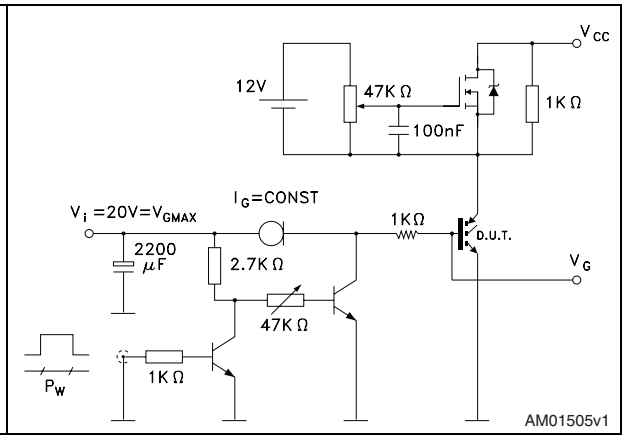
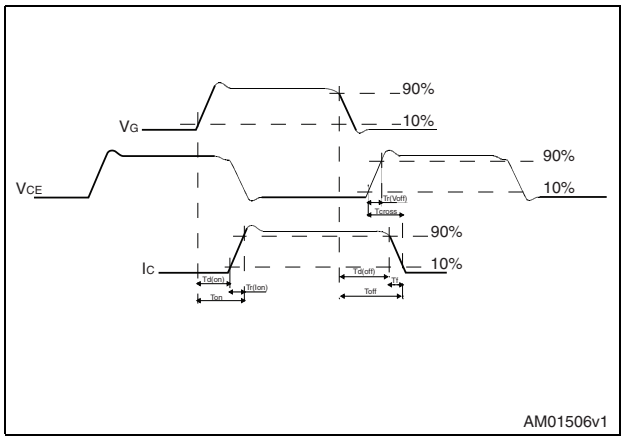


Figure 16. Switching waveform



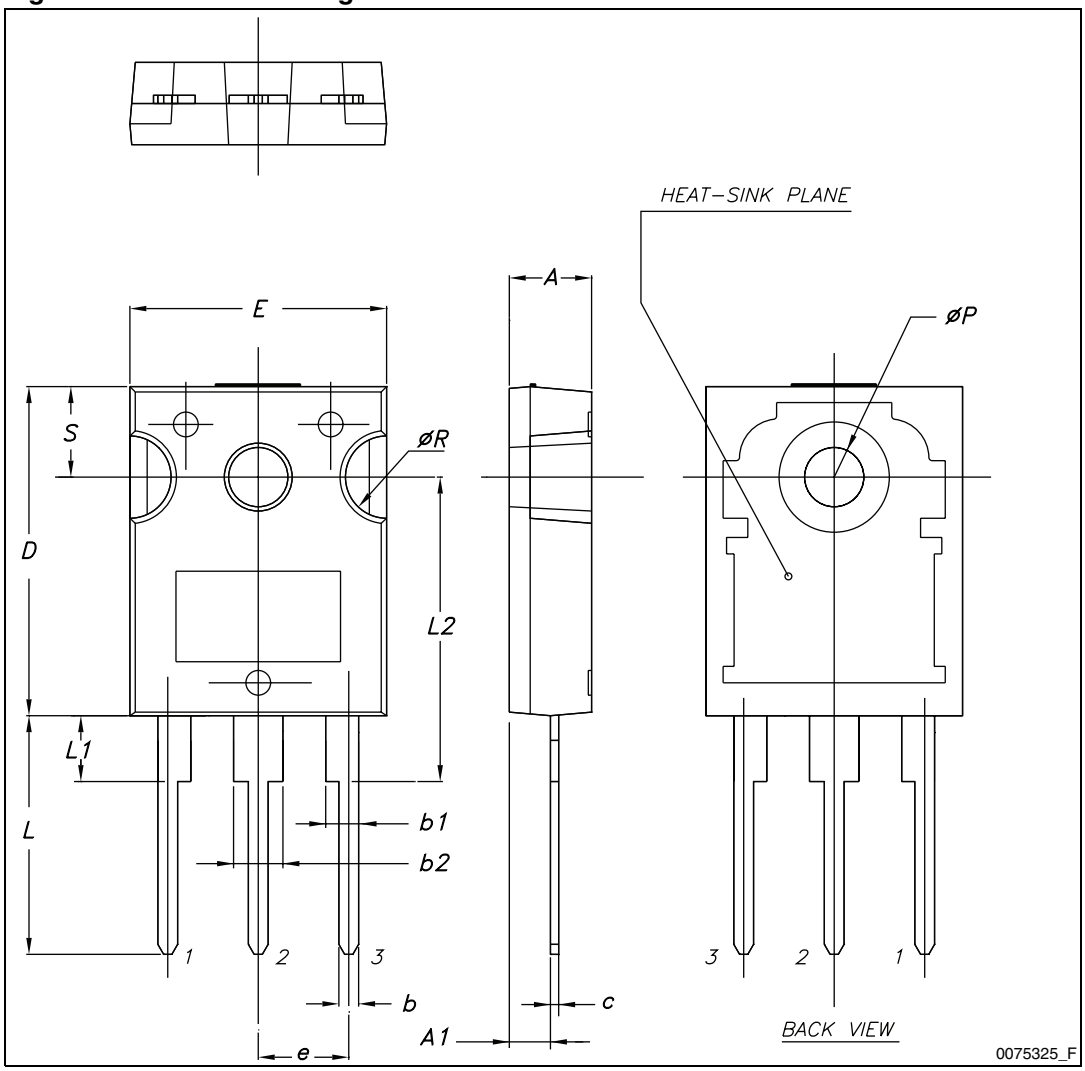
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. TO-247 mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
∅P	3.55		3.65
∅R	4.50		5.50
S		5.50	

Figure 17. TO-247 drawing



5 Revision history

Table 9. Document revision history

Date	Revision	Changes
18-Jan-2010	1	Initial release.
21-Jan-2011	2	Document status promoted from preliminary data to datasheet.

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